ON Semiconductor

Is Now



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MOSFET – Power, Single, N-Channel 40 V, 10.3 m Ω , 37 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	40	٧
Gate-to-Source Voltage	9		V_{GS}	±20	٧
Continuous Drain		T _C = 25°C	I _D	37	Α
Current R _{0JC} (Notes 1, 3)	Steady	T _C = 100°C		26	
Power Dissipation	State	T _C = 25°C	P_{D}	28	W
R _{θJC} (Note 1)		T _C = 100°C		14	
Continuous Drain		T _A = 25°C	I _D	13	Α
Current R _{0JA} (Notes 1, 2, 3)	Steady	T _A = 100°C		9.2	
Power Dissipation	State	T _A = 25°C	P _D	3.5	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.7	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	190	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	31	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2 A)			E _{AS}	95	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	5.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	43	

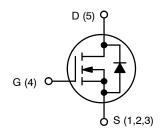
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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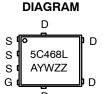
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	10.3 m Ω @ 10 V	07.4
40 V	17.6 mΩ @ 4.5 V	37 A



N-CHANNEL MOSFET



DFN5 (SO-8FL) CASE 488AA STYLE 1



MARKING

5C468L = Specific Device Code A = Assembly Location

Y = Year

W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

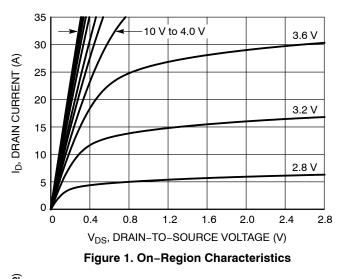
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				•	•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				24		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	
		V _{DS} = 40 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							-
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 20 \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A		8.6	10.3	_
		V _{GS} = 4.5 V	I _D = 20 A		14.5	17.6	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _E) = 20 A		33		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				•	•	
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 20 V			570		
Output Capacitance	Coss				230		pF
Reverse Transfer Capacitance	C _{RSS}				11		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 20 A			7.3		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V}; I_D = 20 \text{ A}$			3.4		nC
Threshold Gate Charge	Q _{G(TH)}				0.9		
Gate-to-Source Charge	Q_{GS}				1.6		
Gate-to-Drain Charge	Q_{GD}				1.0		
Plateau Voltage	V_{GP}				3.4		V
SWITCHING CHARACTERISTICS (Note 5	i)						-
Turn-On Delay Time	t _{d(ON)}				7		
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 20 V, I_D = 20 A, R_G = 1.0 Ω			43		1
Turn-Off Delay Time	t _{d(OFF)}				11		ns ns
Fall Time	t _f				2		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						-
Forward Diode Voltage	rd Diode Voltage V_{SD} $V_{CS} = 0.5$	V _{GS} = 0 V,	T _J = 25°C		0.88	1.2	
		I _S = 20 A	T _J = 125°C		0.79		v
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A}/\mu\text{s,}$ $I_{S} = 20 \text{ A}$			18		
Charge Time	ta				9		ns
Discharge Time	t _b				9		
Reverse Recovery Charge	Q _{RR}				6		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

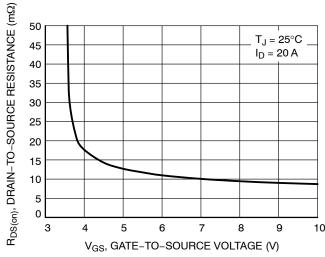
5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



35 V_{DS} = 10 V 30 ID, DRAIN CURRENT (A) 25 20 15 $T_J = 25^{\circ}C$ 10 5 $T_J = 125^{\circ}C$ $T_J = -55^{\circ}C$ 0 0 2 3 V_{GS}, GATE-TO-SOURCE VOLTAGE (V)

Figure 2. Transfer Characteristics



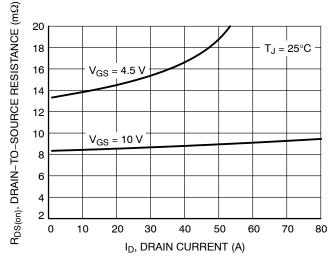
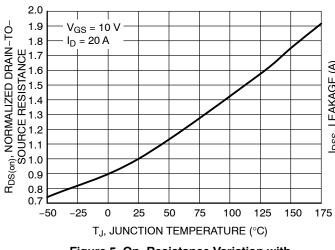


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Drain Current and Gate Voltage



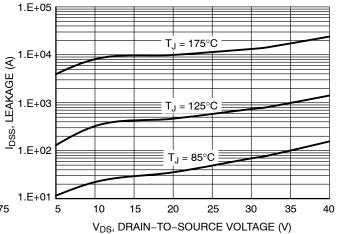
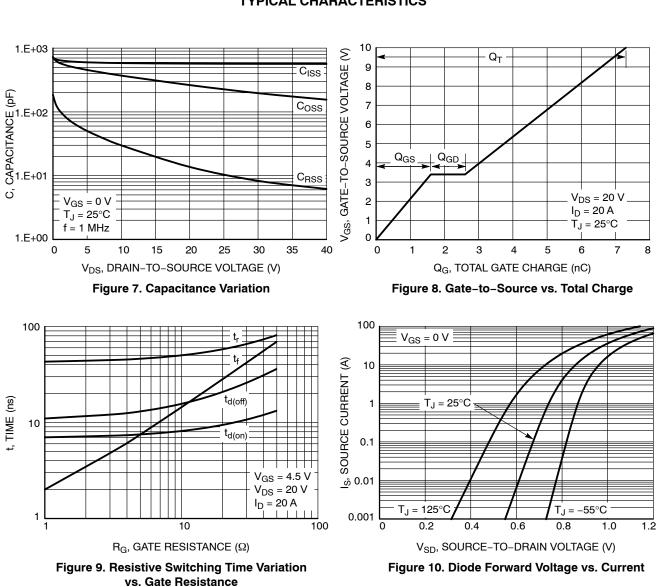


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



100

1000 (V) 100 (V) 100

Figure 11. Safe Operating Area

10 T_J (initial) = 25°C

1 T_J (initial) = 100°C 10.1 1E-4 1E-3 1E-2 TIME IN AVALANCHE (s)

Figure 12. I_{PEAK} vs. Time in Avalanche

TYPICAL CHARACTERISTICS

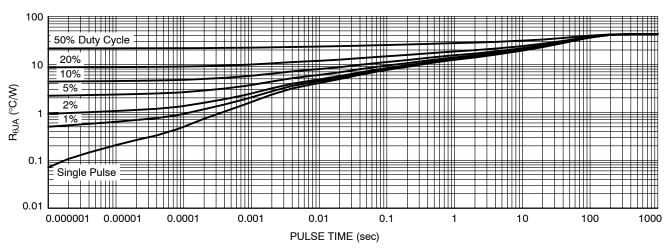


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS5C468NLT1G	5C468L	DFN5 (Pb-Free)	1500 / Tape & Reel
NTMFS5C468NLT3G	5C468L	DFN5 (Pb-Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SCALE 2:1

0.10

0.10

SIDE VIEW



DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.90	1.00	1.10		
A1	0.00		0.05		
b	0.33	0.41	0.51		
С	0.23	0.28	0.33		
D	5.00	5.15	5.30		
D1	4.70	4.90	5.10		
D2	3.80	4.00	4.20		
E	6.00	6.15	6.30		
E1	5.70	5.90	6.10		
E2	3.45	3.65	3.85		
е		1.27 BSC			
G	0.51	0.575	0.71		
K	1.20	1.35	1.50		
L	0.51	0.575	0.71		
L1	0.125 REF				
М	3.00	3.40	3.80		
θ	0 °		12 °		

GENERIC MARKING DIAGRAM*



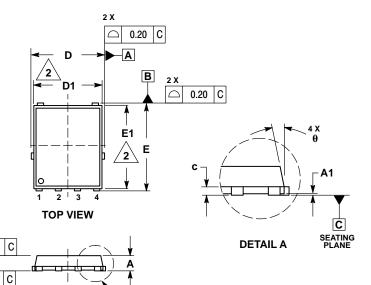
XXXXXX = Specific Device Code

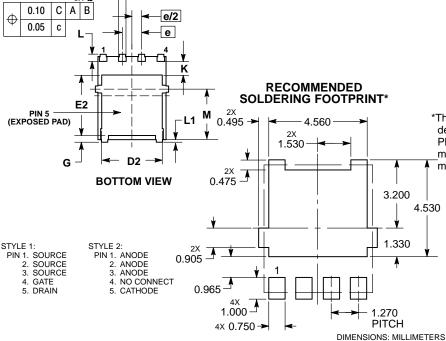
= Assembly Location Α

Υ = Year W = Work Week

ZZ = Lot Traceability

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.





DETAIL A

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DFN5 5x6, 1.27P (SO-8FL)		PAGE 1 OF 1	

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